

# **Data Sheet**

# **Description**

The FMEN-210A is a 100 V, 10 A Schottky diode with allowing improvements in V<sub>F</sub> characteristic.

These characteristic features contribute to improving power supply efficiency and to enabling high-frequency systems.

#### **Features**

•	V <sub>RM</sub> 100	1
	14.12	
•	$I_{F(AV)}10$	P
•	$V_F (I_F = 5 \text{ A})$ 0.80 V ty	p
_	Para I and Frame: Dh fran (Paus Compliant)	

- Bare Lead Frame: Pb-free (RoHS Compliant)
- Flammability: Equivalent to UL94V-0

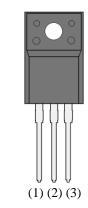
# **Applications**

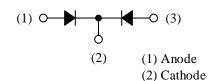
High speed switching applications as follows:

- DC-DC Converter
- Adapter

# **Package**

TO220F-3L





Not to scale

(3) Anode

## FMEN-210A

## **Absolute Maximum Ratings**

Unless otherwise specified,  $T_A = 25$  °C.

Parameter	Symbol	Conditions	Rating	Unit
Nonrepetitive Peak Reverse Voltage <sup>(1)</sup>	$V_{RSM}$		100	V
Repetitive Peak Reverse Voltage <sup>(1)</sup>	$V_{RM}$		100	V
Average Forward Current	I <sub>F(AV)</sub>	See Figure 1 and Figure 2.	10	A
Surge Forward Current <sup>(1)</sup>	I <sub>FSM</sub>	Half cycle sine wave, positive side, 10 ms, 1 shot	100	A
I <sup>2</sup> t Limiting Value <sup>(1)</sup>	$I^2t$	$1 \text{ ms} \le t \le 10 \text{ ms}$	50	$A^2s$
Junction Temperature	$T_{J}$		-40 to 150	°C
Storage Temperature	$T_{STG}$		-40 to 150	°C

#### **Electrical Characteristics**

Unless otherwise specified,  $T_A = 25$  °C.

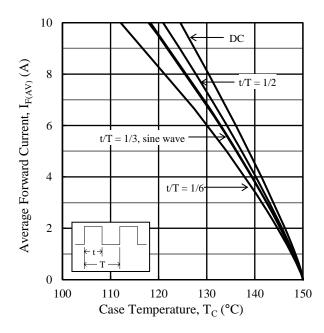
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage Drop <sup>(1)</sup>	$V_{\mathrm{F}}$	$I_F = 5 A$		0.80	0.85	V
Reverse Leakage Current <sup>(1)</sup>	$I_R$	$V_R = V_{RM}$	_	_	100	μΑ
Reverse Leakage Current under High Temperature <sup>(1)</sup>	$H \cdot I_R$	$V_R = V_{RM}$ , $T_J = 150$ °C		_	50	mA
Thermal Resistance <sup>(2)</sup>	R <sub>th(J-C)</sub>			_	4.0	°C/W

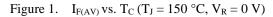
## **Mechanical Characteristics**

Parameter	Conditions	Min.	Typ.	Max.	Unit
Heatsink Mounting Screw Torque		0.490		0.686	N·m
Package Weight		_	1.8	_	g

 $<sup>^{(1)}</sup>$  Specifies a value per chip; the FMEN-210A consists of two chips.  $^{(2)}$  R<sub>th (J-C)</sub> is thermal resistance between junction and the case. The case temperature is measured at the back side near the screw hole.

## **Derating Curves**





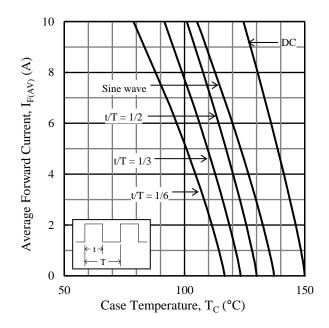


Figure 2.  $I_{F(AV)}$  vs.  $T_C$  ( $T_J = 150$  °C,  $V_R = 100$  V)

#### **Characteristic Curves**

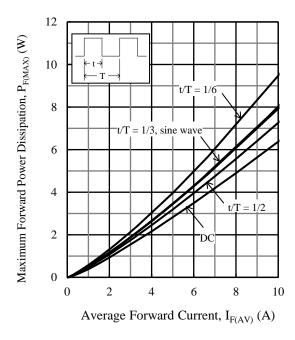


Figure 3.  $P_{F(MAX)}$  vs.  $I_{F(AV)}$  ( $T_J = 150$  °C)

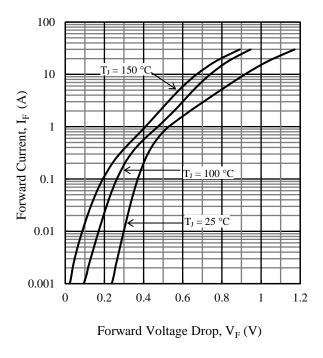


Figure 5. Typical Characteristics:  $I_F$  vs.  $V_F$ 

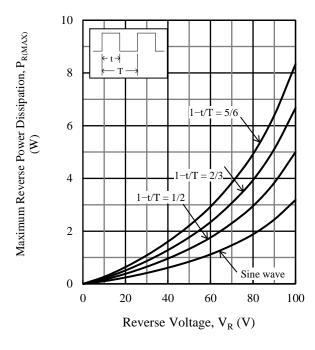


Figure 4.  $P_{R(MAX)}$  vs.  $V_R$  ( $T_J = 150$  °C)

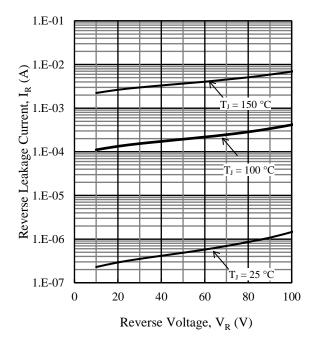


Figure 6. Typical Characteristics: I<sub>R</sub> vs. V<sub>R</sub>

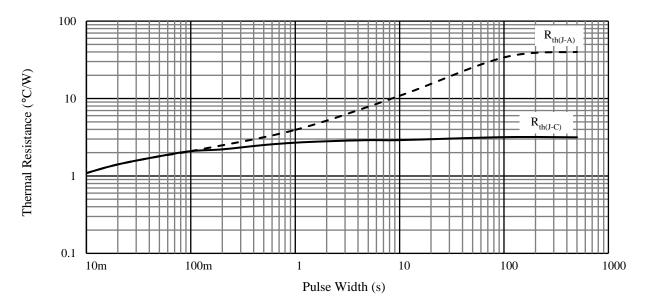
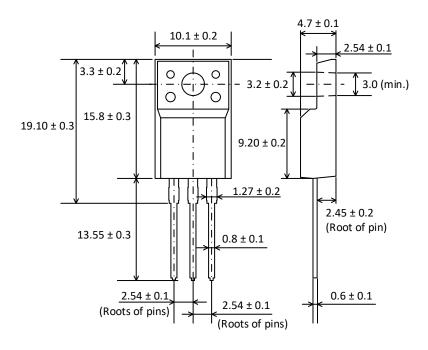


Figure 7. Typical Transient Thermal Resistance Characteristics

## **Physical Dimensions**

• TO220F-3L



#### **NOTES:**

- Dimensions in millimeters
- All the dimensions exclude mold flashes.
- Bare lead frame: Pb-free (RoHS compliant)
- When soldering the products, it is required to minimize the working time within the following limits:

Flow: 260 °C / 10 s, 1 time

Soldering Iron:  $350 \, ^{\circ}\text{C} \, / \, 3.5 \, \text{s}, \, 1 \, \text{time}$ 

Soldering should be at a distance of at least 1.5 mm from the body of the product.

## **Marking Diagram**

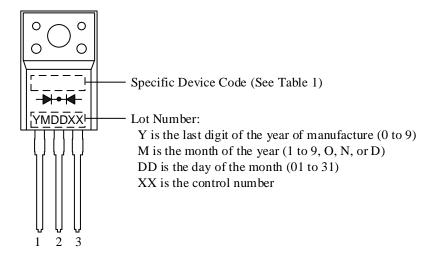


Table 1. Specific Device Code

Specific Device Code	Part Number
EN210A	FMEN-210A

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